Electrodeposited nickel nanowires for magnetic-field effect transistor (MagFET)

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Abstract
The growing interest in magnetic nanowires (NW) is connected to possibility of employing them for advanced applications in wide technological fields, such as data storage and biotechnology. In addition, NW can be used as sensor devices for several applications, since they present high sensitivity to the environment. One of the major challenges when dealing with transport measurements in NW is to trap them between electrodes, which allows electrical characterization and therefore fabrication of nanowire-based devices. This can be used for investigation of electrical transport properties of individual NW and fabrication of NW-based devices, such as sensors and field effect transistors. Especially for ferromagnetic NW, one can use the present method for fabrication of magnetic field-effect transistors (MagFET).

Key words:  
nickel nanowires; nanowire-based devices; magnetoresistance, Focused Ion Beam (FIB).

Introduction
Therefore, in this work, properly isolated NiNW, with length of around 4 µm and 35 nm of diameter, obtained by electrodeposition. Optimized electrodes geometry and DEP electrical parameters [13] were taken for NiNW deposition. In addition, electrical characterizations of the NW and of the contact resistance between the NW and electrode were performed by current versus voltage curves. Significant reduction of contact resistance was achieved by ion-beam assisted deposition of Pt cap layers on the NW extremities. The main objective of this work is to study Ni nanowires (NiNW) for the future MagFET applications. This device works based on anisotropic magnetoresistance (AMR), a quantum-mechanical effect based on spin-orbit coupling, which allows current modulation through the NW by an external magnetic field [16].

Results and Discussion
The electric resistivity of the NiNW, ρ, was measured as a function of temperature, T, using a standard four-probe technique in a Physical Property Measurement System (PPMS), in the range of 2 – 300 K (Fig. 7), showing metallic behavior, as expected. The residual resistance is ρ₀ = 27 Ω.cm, which is in good agreement with similar dimensions NiNW [4,18]. The relative ratio of resistivity ρ (300 K) / ρ (4.2 K) = 2 is much smaller than the value of 47 for the bulk [4]. Since the NW dimensions and grain-size are similar to the mean free path of Ni (~10 nm) the increase in resistivity can be attributed mainly to the grain-boundary scattering [16,17].

The variation of ρ as a function of the magnetic field, H, was measured at 300 K for one isolated nanowire with the current flowing perpendicular to the applied field. Maximum resistivity value, decreases down to around 1% as the magnetic field increases, as expected for NiNW. This behavior is attributed to the quantum-mechanical effect of spin-orbit coupling for magnetic fields below 10 kOe. MR x H for temperatures of 300, 100 and 2 K. Changes in MR with T are closely related to changes in magnetic anisotropy due to the thermal expansion coefficients mismatch between the SiO₂ (αSO₂ = 0.65 x 10⁻⁶ K⁻¹) substrate and the NiNW (αNi = 13 x 10⁻⁶ K⁻¹). Where Kₙi = 25 x 10¹⁰ N.m⁻² is the elastic constant for bulk Ni. For ΔT = 300 K – 2K = 298 K, the induced stress in a NiNW is approximately 0.92 GN.m⁻². Such a tensile stress on the NiNW, which is thermally dependent, can alter its magnetoelastic anisotropy, thus changing the preferred magnetization direction from longitudinal to transversal (parallel to H). This leads to reduction in MR signal for NiNW.

Conclusions
NiNW present ferromagnetic properties, which allow their low current levels to be controlled through magnetic fields, like a MagFET device. These magnetotransport properties can be thought as a promising alternative to the traditional Si-based MOSFET devices.

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